

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yasushi Kawauchi	12/22/2009
Katsuhiko Kimura	12/15/2009
RECEIVING PARTY DATA	
Name:	DAIKYO SEIKO, LTD.
Street Address:	38-2, Sumida 3-chome
City:	Sumida-ku, Tokyo
State/Country:	JAPAN
Postal Code:	131-0031
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12668377
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ATTORNEY DOCKET NUMBER:	YK3030-0055
NAME OF SUBMITTER:	David J. Kenealy
Total Attachments: 2 source=YK3030-0055 Assignment as-filed#page1.tif source=YK3030-0055 Assignment as-filed#page2.tif	

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PATENT
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ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

RUBBER COMPOUND AND MOLDED ARTICLE

for which WE filed international application PCT/ JP2008/060528 on June 9, 2008 and for which we executed an application for United States Letters Patent concurrently herewith; and

WHEREAS DAIKYO SEIKO, LTD. whose post office address is 38-2, Sumida 3-chome, Sumida-ku, Tokyo 131-0031, Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

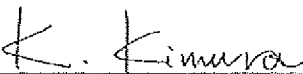
AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 12/666,377, filed January 8, 2010) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor KAWAUCHI, Yasushi	Assignor's Signature <i>Yasushi Kawauchi</i>	Date <i>December 22, 2009</i>
Address: c/o DAIKYO SEIKO, LTD., 38-2, Sumida 3-chome, Sumida-ku, Tokyo 131-0031, Japan		Citizenship Japanese
Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

Cermak Kenealy Vaidya & Nakajima LLP

<u>Full Name of Second Assignor</u> KIMURA, Katsuhiko	<u>Assignor's Signature</u> 	<u>Date</u> Dec 15, 2009
<u>Address:</u> c/o KANEKA CORPORATION, 5-1-1, Torikai-nishi, Settsu-shi, Osaka 566-0072, Japan		<u>Citizenship:</u> Japanes
<u>Full Name of Third Assignor</u>	<u>Assignor's Signature</u>	<u>Date</u>
<u>Address:</u>		<u>Citizenship:</u>
<u>Full Name of Fourth Assignor</u>	<u>Assignor's Signature</u>	<u>Date</u>
<u>Address:</u>		<u>Citizenship:</u>
<u>Full Name of Fifth Assignor</u>	<u>Assignor's Signature</u>	<u>Date</u>
<u>Address:</u>		<u>Citizenship:</u>
<u>Full Name of Sixth Assignor</u>	<u>Assignor's Signature</u>	<u>Date</u>
<u>Address:</u>		<u>Citizenship:</u>
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		

Cernak Kenealy Vaidya & Nakajima LLP

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RECORDED: 01/11/2010

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